

## MI5812-VB Datasheet

## Dual N-Channel 30 V (D-S) MOSFET

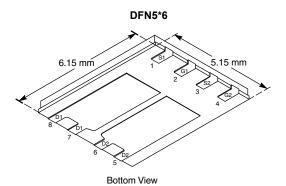
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A)		
30	0.018 at V <sub>GS</sub> = 10 V	22		

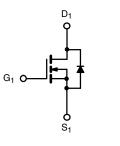
#### FEATURES

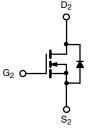
- Halogen-free According to IEC 61249-2-21
  Definition
- Trench Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC



COMPLIANT HALOGEN FREE Available







N-Channel MOSFET

N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)							
Parameter		Symbol	10 s	Steady State	Unit		
Drain-Source Voltage		V <sub>DS</sub>	30		V		
Gate-Source Voltage		V <sub>GS</sub>	± 20				
Continuous Drain Current (T <sub>1</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 25 °C	L	22				
Continuous Drain Current $(1) = 150^{\circ}$ C)	T <sub>A</sub> = 70 °C	I <sub>D</sub>	15		А		
Pulsed Drain Current		I <sub>DM</sub>	50		A		
Continuous Source Current (Diode Conduction) <sup>a</sup>		۱ <sub>S</sub>	2.9				
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C	Р	3.5 2.2		W		
Maximum Fower Dissipation	T <sub>A</sub> = 70 °C	P <sub>D</sub>			vv		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C		
Soldering Recommendations (Peak Temperature)		260		60			

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
	$t \le 10 s$	R <sub>thJA</sub>	26	35	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		60	85	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	3.9	5.5	

Notes:

a. Surface mounted on 1" x 1" FR4 board.



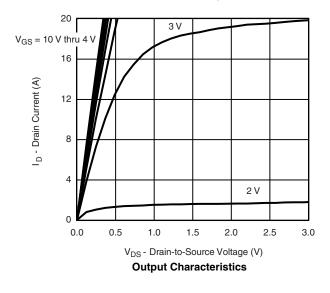
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)								
Parameter	Symbol	bol Test Conditions		Тур.	Max.	Unit		
Static								
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.8		2.4	V		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA		
Zara Cata Valtaga Drain Current	1	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ		
Zero Gate Voltage Drain Current	IDSS	$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			5			
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5$ V, $V_{GS} = 10$ V	20			А		
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		0.018		Ω		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 8.5 \text{ A}$		0.024				
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A		22		S		
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_{S} = 2.9 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.2	V		
Dynamic <sup>b</sup>								
Total Gate Charge	Qg			13	20			
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 10 V, $I_{D}$ = 10 A		2		nC		
Gate-Drain Charge	Q <sub>gd</sub>			2.7				
Gate Resistance	Rg		0.5		3.2	Ω		
Turn-On Delay Time	t <sub>d(on)</sub>			8	16			
Rise Time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 15 \Omega$		10	20			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		21	40	ns		
Fall Time	t <sub>f</sub>			10	20			
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 2.9 A, dl/dt = 100 A/μs		40	80			

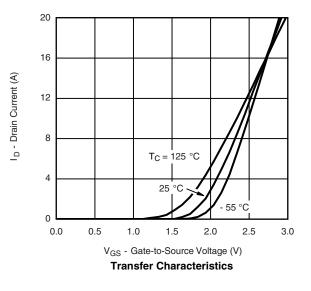
Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

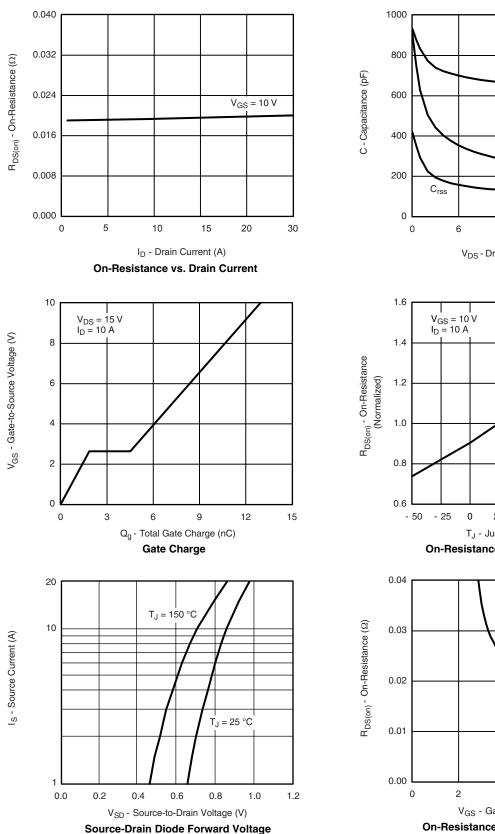
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

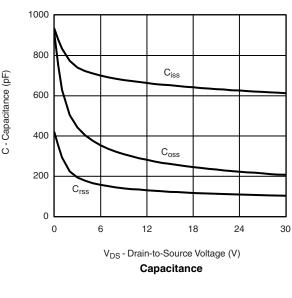


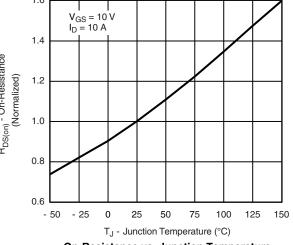




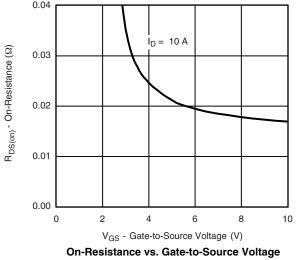


服务热线:400-655-8788

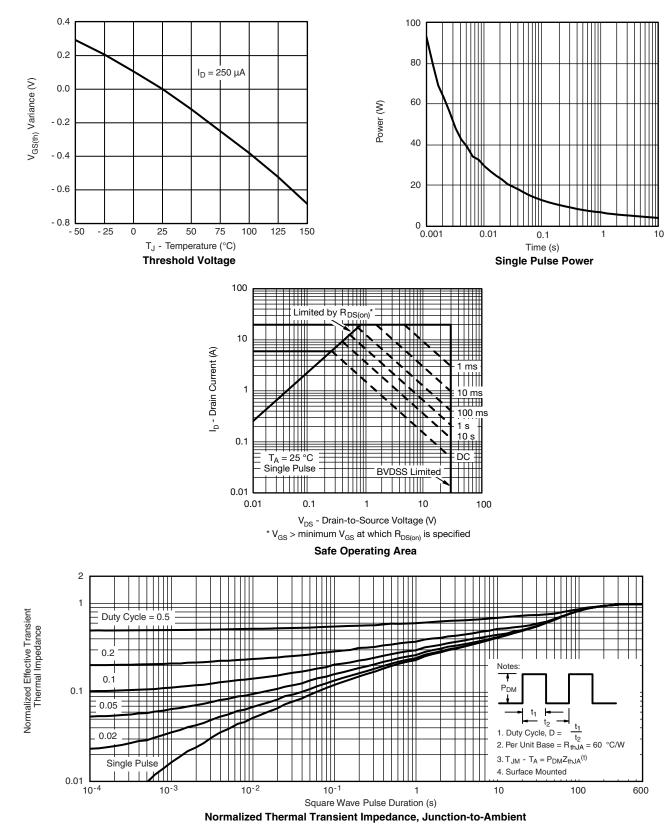




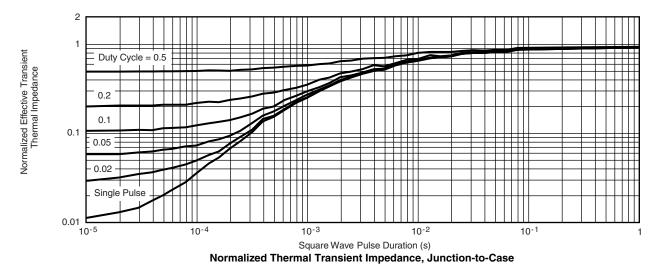
**On-Resistance vs. Junction Temperature** 





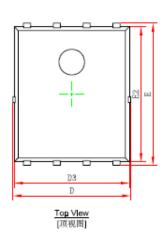


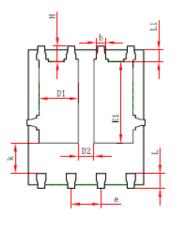




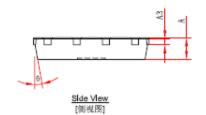


#### PDFNWB5×6-8L-A PACKAGE OUTLINE DIMENSIONS





<u>Bottom Vlew</u> [背视图]



Symbol	Dimensions	In Millimeters	Dimensions In Inches			
	Min.	Max.	Min.	Max.		
A	0.900	1.000	0.035	0.039		
A3	0.254	REF.	0.010	REF.		
D	4.944	5.096	0.195	0.201		
E	5.974	6.126	0.235	0.241		
D1	1.470	1.870	0.058	0.074		
D2	0.470	0.870	0.019	0.034		
E1	3.375	3.575	0.133	0.141		
D3	4.824	4.976	0.190	0.196		
E2	5.674	5.826	0.223	0.229		
k	1.190	1.390	0.047	0.055		
b	0.350	0.450	0.014	0.018		
e	1.270	)TYP.	0.050	0.050TYP.		
L	0.559	0.711	0.022	0.028		
L1	0.424	0.576	0.017	0.023		
Н	0.574	0.726	0.023	0.029		
θ	10°	12°	10°	12°		



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